PD-96006B

# International

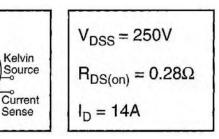
#### HEXFET<sup>®</sup> Power MOSFET

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Current Sense
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

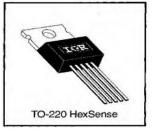
#### Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The HEXSense device provides an accurate fraction of the drain current through the additional two leads to be used for control or protection of the device. These devices exhibit similar electrical and thermal characteristics as their IRF-series equivalent part numbers. The provision of a kelvin source connection effectively eliminates problems of common source inductance when the HEXSense is used as a fast, high-current switch in non current-sensing applications.



IRC644PbF



#### **Absolute Maximum Ratings**

	Parameter	Max.	Units	
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, VGS @ 10 V	14		
Ip @ Tc = 100°C	Continuous Drain Current, VGS @ 10 V	8.5	A	
IDM	Pulsed Drain Current ①	56		
Pp @ Tc = 25°C	Power Dissipation	125	W	
	Linear Derating Factor	1.0	W/°C	
Vas	Gate-to-Source Voltage	±20	V	
EAS	Single Pulse Avalanche Energy ②	550	mJ	
IAR	Avalanche Current ①	14	A	
EAR	Repetitive Avalanche Energy ①	13	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	4.8	V/ns	
TJ TSTG	Operating Junction and Storage Temperature Range	-55 to +150	°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1 N•m)		

٩D

#### Thermal Resistance

	Parameter	Min.	Тур.	Max.	Units
Rejc	Junction-to-Case	_	-	1.0	
Recs	Case-to-Sink, Flat, Greased Surface	-	0.50	-	°C/W
Reja	Junction-to-Ambient		—	62	7

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	Parameter	Min.	Typ.	Max.	Units	Test Conditions	
V(BR)DSS	Drain-to-Source Breakdown Voltage	250	-	-	V	V <sub>GS</sub> =0V, I <sub>D</sub> = 250µA	
ΔV(BR)DSS/ΔTJ	Breakdown Voltage Temp. Coefficient	-	0.37	-	V/°C	Reference to 25°C, ID= 1mA	
RDS(on)	Static Drain-to-Source On-Resistance	-	-	0.28	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =8.4A ④	
VGS(th)	Gate Threshold Voltage	2.0	-	4.0	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = 250µA	
g <sub>fs</sub>	Forward Transconductance	6.6	-	-	S	VDS=50V, ID=8.4A @	
1	Delta la Occura la classa Occurat		-	25		V <sub>DS</sub> =250V, V <sub>GS</sub> =0V	
IDSS	Drain-to-Source Leakage Current	-	-	250	μA	V <sub>DS</sub> =200V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C	
Inne	Gate-to-Source Forward Leakage	-	-	100	nA	V <sub>GS</sub> =20V	
lass	Gate-to-Source Reverse Leakage	-	-	-100	IIA	V <sub>GS</sub> =-20V	
Qg	Total Gate Charge	-		65		ID=14A	
Qgs	Gate-to-Source Charge	-	-	11	nC	V <sub>DS</sub> =200V V <sub>GS</sub> =10V See Fig. 6 and 13 6	
Qgd	Gate-to-Drain ("Miller") Charge	-	-	32			
td(on)	Turn-On Delay Time	-	12	-		V <sub>DD</sub> =125V	
tr	Rise Time	-	37	-	ns	ID=14A	
td(off)	Turn-Off Delay Time	-	49	-	1.5	R <sub>G</sub> =9.1Ω	
tı	Fall Time	-	29	-		R <sub>D</sub> =8.7Ω See Figure 10 ④	
Lo	Internal Drain Inductance	-	4.5	-	nH	Between lead, 6 mm (0.25in.) from package	
Ls	Internal Source Inductance	-	7.5	-		from package and center of die contact	
Ciss	Input Capacitance	-	1200	-		V <sub>GS</sub> =0V	
Coss	Output Capacitance		310	-	pF	VDS=25V	
Crss	Reverse Transfer Capacitance	-	90	-		f=1.0MHz See Figure 5	
r	Current Sensing Ratio	2630	+	2900	-	ID=14A, VGS=10V	
Coss	Output Capacitance of Sensing Cells	-	9.0	-	pF	VGS=0V, VDS= 25V, f=1.0MHz	

#### Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

#### Source-Drain Ratings and Characteristics

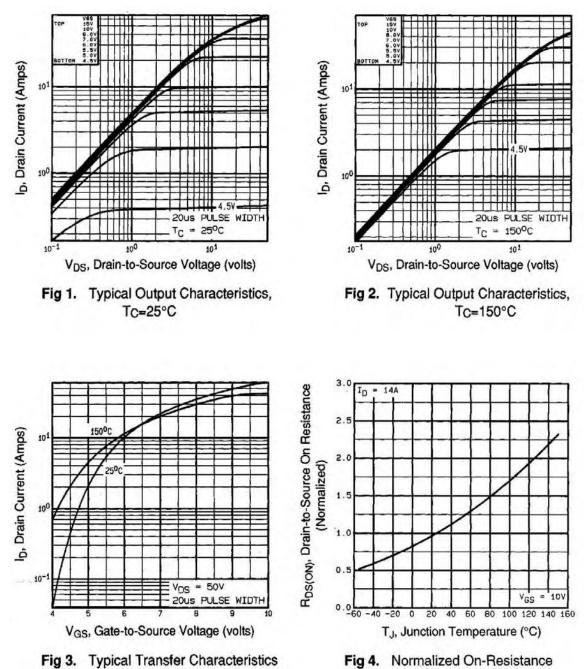
	Parameter	Min.	Тур.	Max.	Units	Test Conditions
ls	Continuous Source Current (Body Diode)	-	-	14	A	MOSFET symbol showing the
ISM .	Pulsed Source Current (Body Diode) ①	-	-	56		p-n junction diode.
VSD	Diode Forward Voltage	-	-	1.8	V	T_J=25°C, Is=14A, VGS=0V @
trr	Reverse Recovery Time	-	310	670	ns	T_J=25°C, IF=14A
Qrr	Reverse Recovery Charge	-	3.5	7.3	μC	di/dt=100A/µs ⊛
ton	Forward Turn-On Time	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+LD)				

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)
- ③ Isp≤14A, di/dt≤150A/µs, V<sub>DD</sub>≤V(BR)DSS, T<sub>J</sub>≤150°C
- ② V<sub>DD</sub>=50V, starting T<sub>J</sub>=25°C, L=4.50mH R<sub>G</sub>=25Ω, I<sub>AS</sub>=14A (See Figure 12)
- $\textcircled{ Pulse width \leq 300 \ \mu s; duty cycle \leq 2\%. }$

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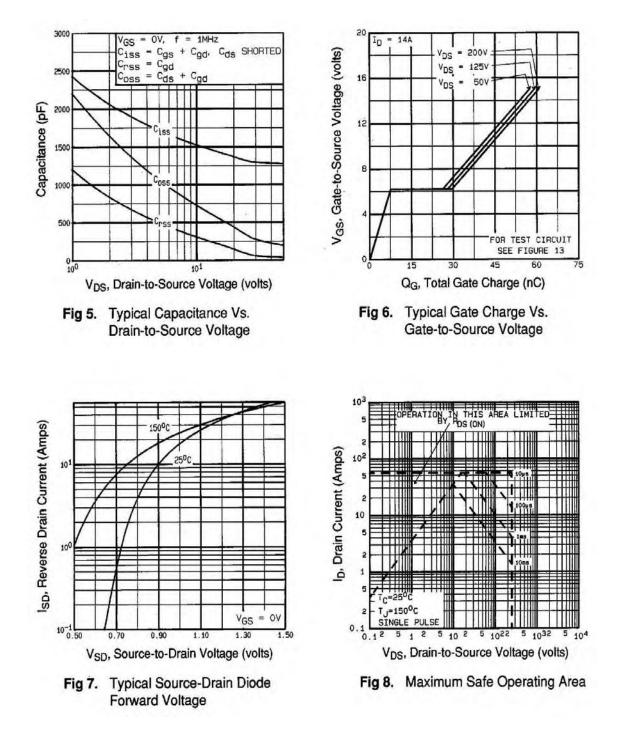
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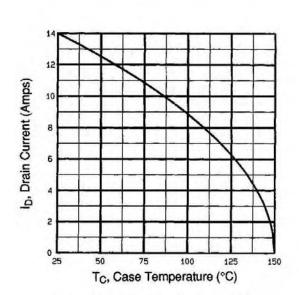
Vs. Temperature

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International

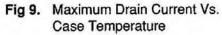


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**ICR** Rectifier



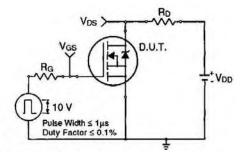


Fig 10a. Switching Time Test Circuit

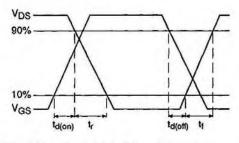


Fig 10b. Switching Time Waveforms

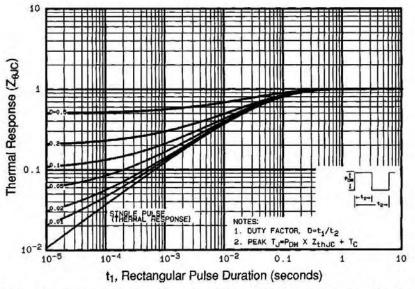


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

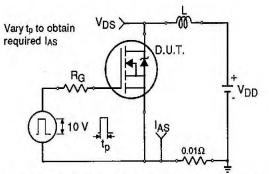
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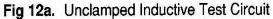
International **TOR** Rectifier

I<sub>D</sub> 6.3A 8.9A 14A

TOP

BOTTOM





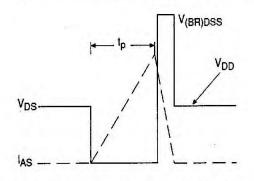
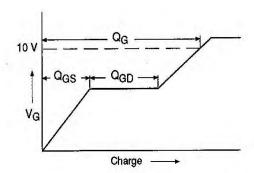
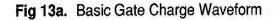


Fig 12b. Unclamped Inductive Waveforms





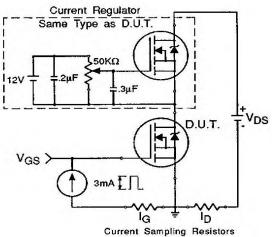
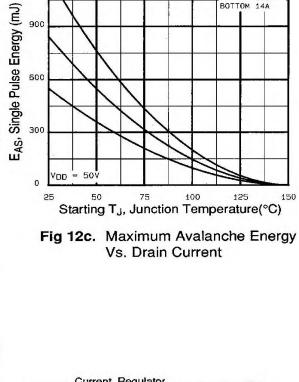


Fig 13b. Gate Charge Test Circuit

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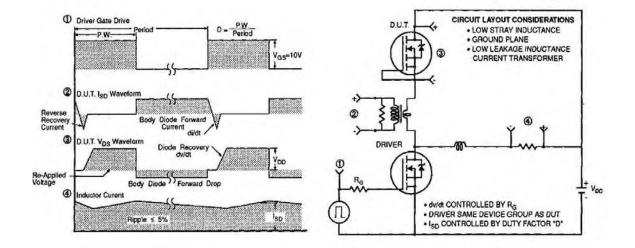
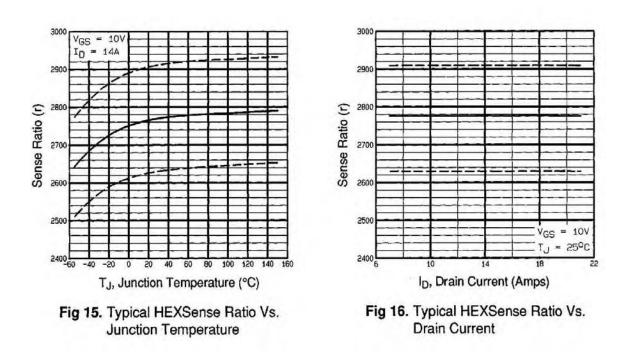


Fig 14. Peak Diode Recovery dv/dt Test Circuit



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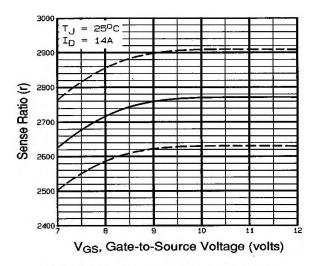
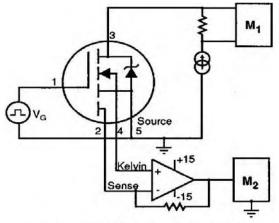
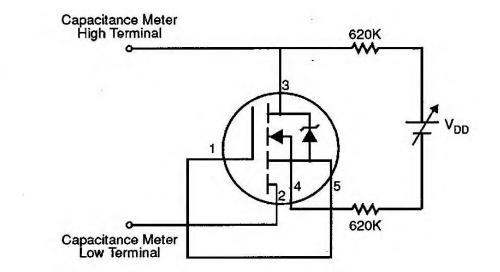


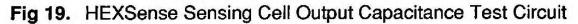
Fig 17. Typical HEXSense Ratio Vs. Gate Voltage



M1, M2 = HIGH SPEED DIGITAL VOLTMETERS

Fig 18. HEXSense Ratio Test Circuit





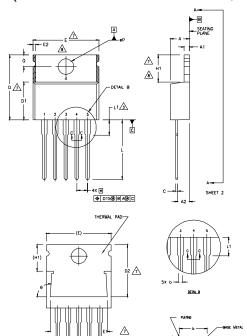
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#### International **TER** Rectifier

### IRC644PbF

#### Hexsense TO-220 5L Package Outline

( Dimensions are shown in millimeters (inches)



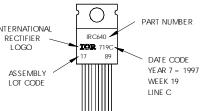
NOTES: DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994.

- DIMENSIONING AND TOLERANCING PER ASME T14.5 M- 1994. DIMENSIONS ARE SHOWN IN INCHES (MILLIMETERS]. LEAD DIMENSION AND FINISH UNCONTROLLED IN L1. DIMENSION D & E DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED. 005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY. 2 3 4
- DIMENSION 51 & c1 APPLY TO BASE METAL ONLY. CONTROLLING DIMENSION : INCHES. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS E,H1,D2 & E1
- DIMENSION E2 X H1 DEFINE A ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED. 8

SYMBOL	MILLIM	ETERS	INC		
	MIN.	MAX.	MIN.	MAX.	NOTES
A	3,56	4,82	,140	.190	
A1	0.51	1.40	.020	.055	
A2	2.04	2.92	.080	.115	
b	0.64	0.88	.025	.035	
b1	0.64	0.84	.025	.033	5
с	0.36	0.61	.014	.024	
c1	0.36	0.56	.014	.022	5
D	14.22	16,51	.560	.650	4
D1	8.38	9.02	.330	.355	
D2	12.19	12.88	.480	.507	7
E	9.66	10,66	.380	.420	4,7
E1	8.38	8.89	.330	.350 BSC	7
е	1.70 BSC		.067		
H1	5.85	6,55	.230	.270	7,8
L	13.47	14.09	.530	.555	
L1	-	6.35	-	.250	3
øР	3.54	4.08	.139	.161	
Q	2.54	3.42	.100	.135	
ø	90'-	-93*	90'-	-93*	
			[		
			[		
			[		

#### Hexsense TO-220 5L Part Marking Information

EXAMPLE: THIS IS AN IRC640 WITH ASSEMBLY INTERNATIONAL LOT CODE 1789 RECTIFIER ASSEMBLED ON WW 19, 1997 LOGO IN THE ASSEMBLY LINE "C" ASSEMBLY Note: "P" in assembly line position indicates "Lead-Free



Data and specifications subject to change without notice.

International **ICR** Rectifier

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